

Description

The TELUX™ series is a clear, non diffused LED for applications where supreme luminous flux is required. It is designed in an industry standard 7.62 mm square package utilizing highly developed (AS) AlInGaP technology.

The supreme heat dissipation of TELUX™ allows applications at high ambient temperatures.

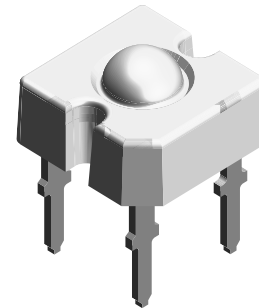
All packing units are binned for luminous flux, forward voltage and color to achieve the most homogenous light appearance in application.

SAE and ECE color requirements for automobile application are available for color red.

ESD resistivity 2kV (HBM) according to MIL STD 883D, method 3015.7.

Features

- Utilizing one of the world's brightest (AS) AlInGaP technologies
- High luminous flux
- Supreme heat dissipation: R_{thJP} is 90 K/W
- High operating temperature: $T_j = + 125\text{ }^{\circ}\text{C}$
- Meets SAE and ECE color requirements for the automobile industry for color red
- Packed in tubes for automatic insertion



16 012

- Luminous flux, forward voltage and color categorized for each tube
- Small mechanical tolerances allow precise usage of external reflectors or lightguides

Applications

- Exterior lighting
- Dashboard illumination
- Tail-, Stop - and Turn Signals of motor vehicles
- Replaces small incandescent lamps
- Traffic signals and signs

Parts Table

Part	Color, Luminous Intensity	Angle of Half Intensity ($\pm\phi$)	Technology
TLWR8900	Red, $\phi_V = 3000\text{ mlm (typ.)}$	45	AlInGaP on GaAs
TLWY8900	Yellow, $\phi_V = 3000\text{ mlm (typ.)}$	45	AlInGaP on GaAs
TLWTG8900	True green, $\phi_V = 3000\text{ mlm (typ.)}$	45	InGaN on SiC
TLWBG8900	Blue green, $\phi_V = 1300\text{ mlm (typ.)}$	45	InGaN on SiC
TLWB8900	Blue, $\phi_V = 650\text{ mlm (typ.)}$	45	InGaN on SiC

Absolute Maximum Ratings

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

TLWR8900, TLWY8900,

Parameter	Test condition	Symbol	Value	Unit
Reverse voltage	$I_R = 100\text{ }\mu\text{A}$	V_R	10	V
DC forward current	$T_{amb} \leq 85\text{ }^{\circ}\text{C}$	I_F	70	mA
Surge forward current	$t_p \leq 10\text{ }\mu\text{s}$	I_{FSM}	1	A
Power dissipation	$T_{amb} \leq 85\text{ }^{\circ}\text{C}$	P_V	187	mW
Junction temperature		T_j	125	$^{\circ}\text{C}$
Operating temperature range		T_{amb}	- 40 to + 110	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	- 55 to + 110	$^{\circ}\text{C}$
Soldering temperature	$t \leq 5\text{ s}$, 1.5 mm from body preheat temperature 100 $^{\circ}\text{C}$ / 30 sec.	T_{sd}	260	$^{\circ}\text{C}$
Thermal resistance junction/ ambient	with cathode heatsink of 70 mm ²	R_{thJA}	200	K/W

TLWTG8900, TLWBG8900, TLWB8900

Parameter	Test condition	Symbol	Value	Unit
Reverse voltage	$I_R = 10\text{ }\mu\text{A}$	V_R	5	V
DC forward current	$T_{amb} \leq 50\text{ }^{\circ}\text{C}$	I_F	50	mA
Surge forward current	$t_p \leq 10\text{ }\mu\text{s}$	I_{FSM}	0.1	A
Power dissipation	$T_{amb} \leq 50\text{ }^{\circ}\text{C}$	P_V	230	mW
Junction temperature		T_j	100	$^{\circ}\text{C}$
Operating temperature range		T_{amb}	- 40 to + 100	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	- 55 to + 100	$^{\circ}\text{C}$
Soldering temperature	$t \leq 5\text{ s}$, 1.5 mm from body preheat temperature 100 $^{\circ}\text{C}$ / 30 sec.	T_{sd}	260	$^{\circ}\text{C}$
Thermal resistance junction/ ambient	with cathode heatsink of 70 mm ²	R_{thJA}	200	K/W
Thermal resistance junction/pin		R_{thJP}	90	K/W

Optical and Electrical Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Red

TLWR8900

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Total flux	$I_F = 70\text{ mA}$, $R_{thJA} = 200\text{ }^{\circ}\text{K/W}$	ϕ_V	2000	3000		mlm
Luminous intensity/Total flux	$I_F = 70\text{ mA}$, $R_{thJA} = 200\text{ }^{\circ}\text{K/W}$	I_V/ϕ_V		0.8		mcd/mlm
Dominant wavelength	$I_F = 70\text{ mA}$, $R_{thJA} = 200\text{ }^{\circ}\text{K/W}$	λ_d	611	615	634	nm
Peak wavelength	$I_F = 70\text{ mA}$, $R_{thJA} = 200\text{ }^{\circ}\text{K/W}$	λ_p		624		nm
Angle of half intensity	$I_F = 70\text{ mA}$, $R_{thJA} = 200\text{ }^{\circ}\text{K/W}$	ϕ		± 45		deg
Total included angle	90 % of Total Flux Captured	$\phi_{0.9V}$		75		deg
Forward voltage	$I_F = 70\text{ mA}$, $R_{thJA} = 200\text{ }^{\circ}\text{K/W}$	V_F	2.0	2.2	2.7	V
Reverse voltage	$I_R = 10\text{ }\mu\text{A}$	V_R	10	20		V
Junction capacitance	$V_R = 0$, $f = 1\text{ MHz}$	C_j		17		pF



TLWY8900

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Total flux	$I_F = 70 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	ϕ_V	2000	3000		mlm
Luminous intensity/Total flux	$I_F = 70 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	I_V/ϕ_V		0.8		mcd/mlm
Dominant wavelength	$I_F = 70 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	λ_d	585	590	597	nm
Peak wavelength	$I_F = 70 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	λ_p		594		nm
Angle of half intensity	$I_F = 70 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	ϕ		± 45		deg
Total included angle	90 % of Total Flux Captured	$\phi_{0.9V}$		75		deg
Forward voltage	$I_F = 70 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	V_F	1.83	2.1	2.7	V
Reverse voltage	$I_R = 10 \text{ }\mu\text{A}$	V_R	10	15		V
Junction capacitance	$V_R = 0$, $f = 1 \text{ MHz}$	C_j		17		pF

True green

TLWTG8900

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Total flux	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	ϕ_V	1000	2000		mlm
Luminous intensity/Total flux	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	I_V/ϕ_V		0.7		mcd/mlm
Dominant wavelength	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	λ_d	509	523	529	nm
Peak wavelength	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	λ_p		518		nm
Angle of half intensity	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	ϕ		± 45		deg
Total included angle	90 % of Total Flux Captured	ϕ		100		deg
Forward voltage	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	V_F		4.4	5.0	V
Reverse voltage	$I_R = 10 \text{ }\mu\text{A}$	V_R	5	10		V
Junction capacitance	$V_R = 0$, $f = 1 \text{ MHz}$	C_j		50		pF
Temperature coefficient of λ_{dom}	$I_F = 30 \text{ mA}$	$TC_{\lambda_{dom}}$		0.02		nm/K

Blue green

TLWBG8900

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Total flux	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	ϕ_V	630	1300		mlm
Luminous intensity/Total flux	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	I_V/ϕ_V		0.7		mcd/mlm
Dominant wavelength	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	λ_d	492	505	510	nm
Peak wavelength	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	λ_p		503		nm
Angle of half intensity	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	ϕ		± 45		deg
Total included angle	90 % of Total Flux Captured	ϕ		100		deg
Forward voltage	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^\circ\text{K/W}$	V_F		4.4	5.0	V
Reverse voltage	$I_R = 10 \text{ }\mu\text{A}$	V_R	5	10		V
Junction capacitance	$V_R = 0$, $f = 1 \text{ MHz}$	C_j		50		pF
Temperature coefficient of λ_{dom}	$I_F = 30 \text{ mA}$	$TC_{\lambda_{dom}}$		0.02		nm/K

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Total flux	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^{\circ}\text{K/W}$	ϕ_V	320	650		mlm
Luminous intensity/Total flux	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^{\circ}\text{K/W}$	I_V/ϕ_V		0.7		mcd/mlm
Dominant wavelength	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^{\circ}\text{K/W}$	λ_d	462	470	476	nm
Peak wavelength	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^{\circ}\text{K/W}$	λ_p		460		nm
Angle of half intensity	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^{\circ}\text{K/W}$	ϕ		± 45		deg
Total included angle	90 % of Total Flux Captured	ϕ		100		deg
Forward voltage	$I_F = 50 \text{ mA}$, $R_{thJA} = 200 \text{ }^{\circ}\text{K/W}$	V_F		4.4	5.0	V
Reverse voltage	$I_R = 10 \text{ } \mu\text{A}$	V_R	5	10		V
Junction capacitance	$V_R = 0$, $f = 1 \text{ MHz}$	C_j		50		pF
Temperature coefficient of λ_{dom}	$I_F = 30 \text{ mA}$	$TC_{\lambda_{dom}}$		0.03		nm/K

Typical Characteristics ($T_{amb} = 25 \text{ }^{\circ}\text{C}$ unless otherwise specified)

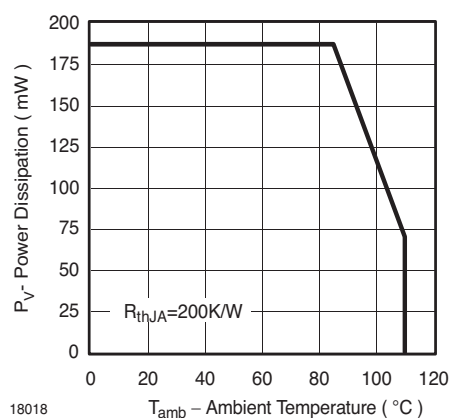


Figure 1. Power Dissipation vs. Ambient Temperature

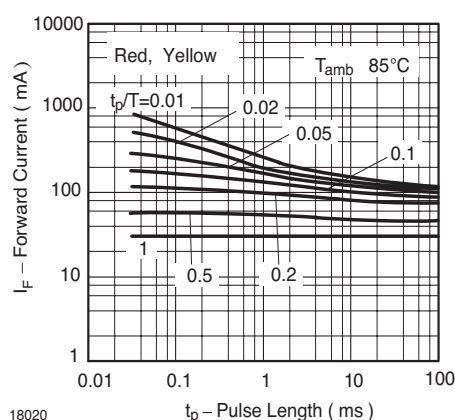


Figure 3. Forward Current vs. Pulse Length

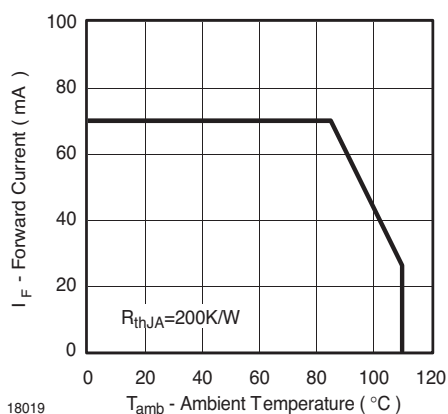


Figure 2. Forward Current vs. Ambient Temperature

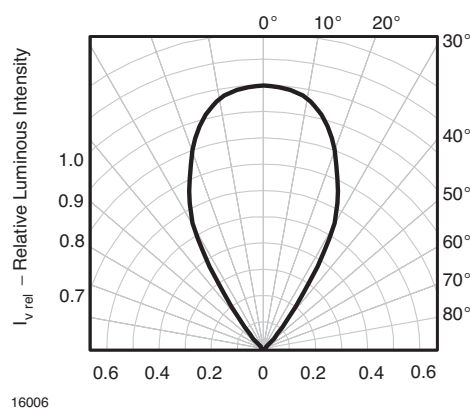


Figure 4. Rel. Luminous Intensity vs. Angular Displacement for 60° emission angle

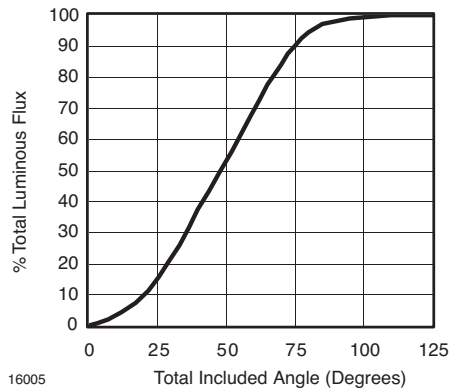


Figure 5. Percentage Total Luminous Flux vs. Total Included Angle for 60° emission angle

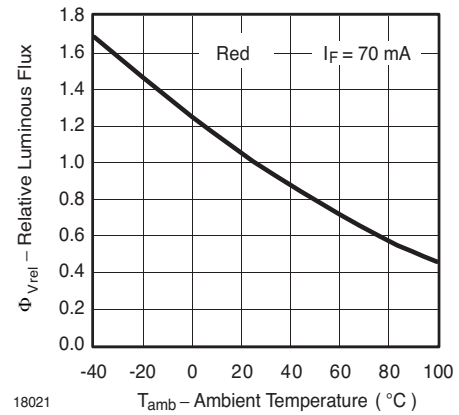


Figure 8. Rel. Luminous Flux vs. Ambient Temperature

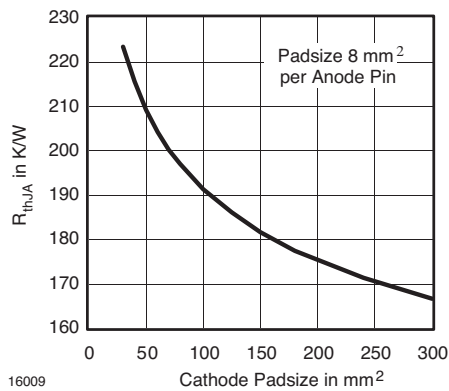


Figure 6. Thermal Resistance Junction Ambient vs. Cathode Padsize

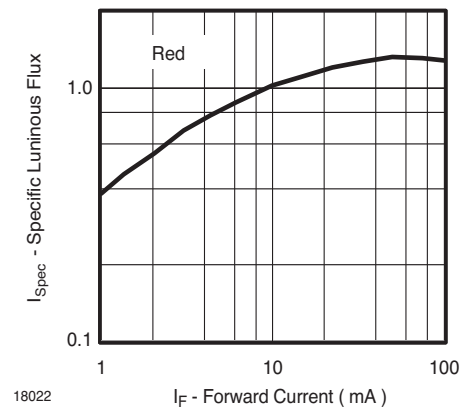


Figure 9. Specific Luminous Flux vs. Forward Current

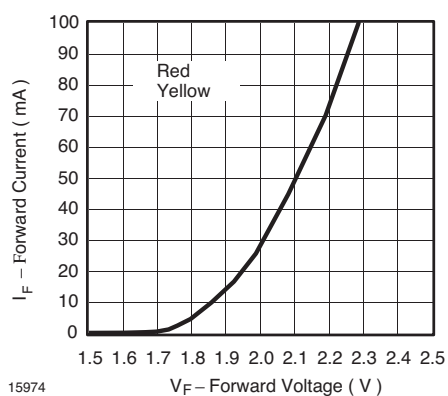


Figure 7. Forward Current vs. Forward Voltage

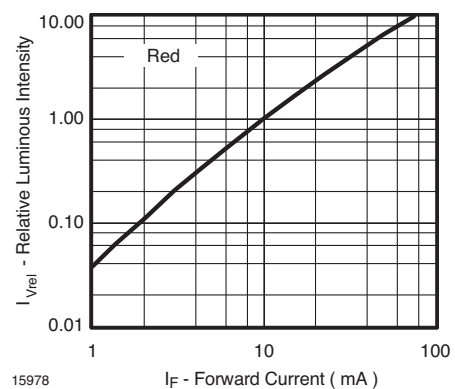


Figure 10. Relative Luminous Flux vs. Forward Current

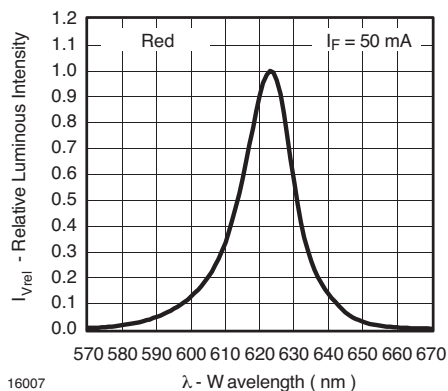


Figure 11. Relative Intensity vs. Wavelength

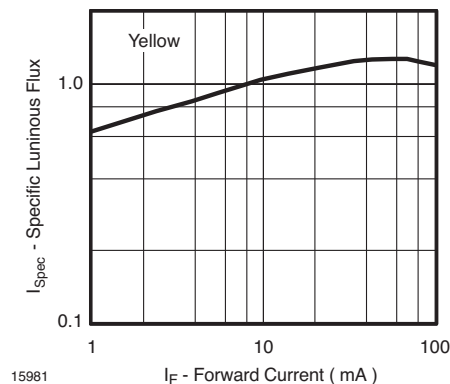


Figure 14. Specific Luminous Flux vs. Forward Current

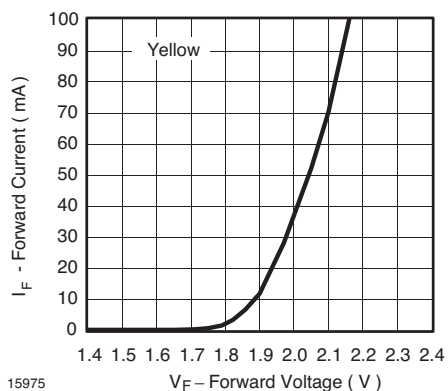


Figure 12. Forward Current vs. Forward Voltage

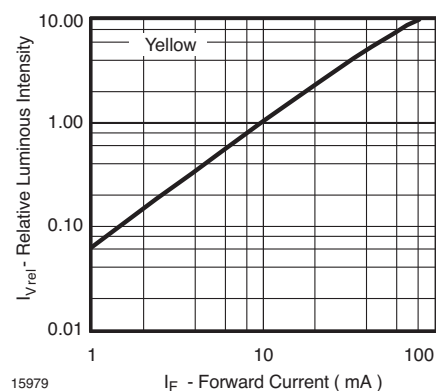


Figure 15. Relative Luminous Flux vs. Forward Current

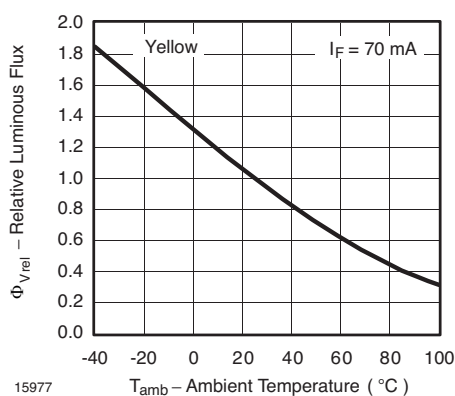


Figure 13. Rel. Luminous Flux vs. Ambient Temperature

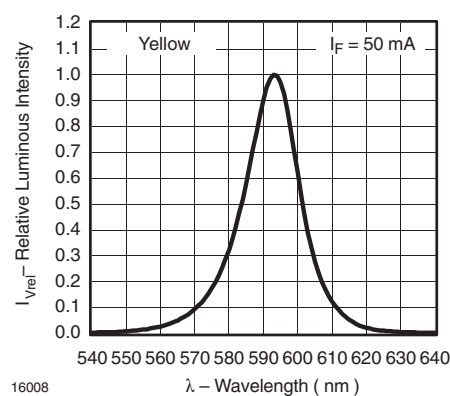


Figure 16. Relative Intensity vs. Wavelength

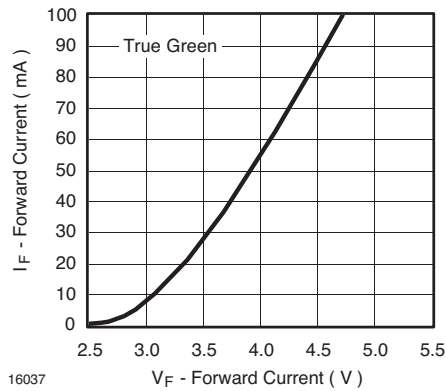


Figure 17. Forward Current vs. Forward Voltage

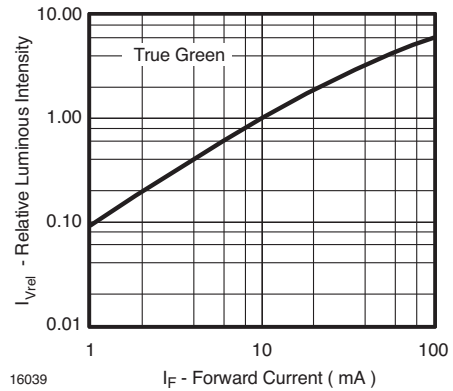


Figure 20. Relative Luminous Flux vs. Forward Current

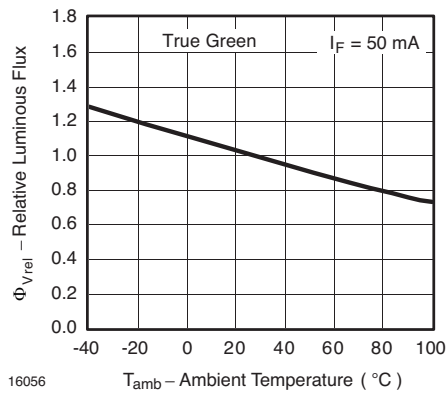


Figure 18. Rel. Luminous Flux vs. Ambient Temperature

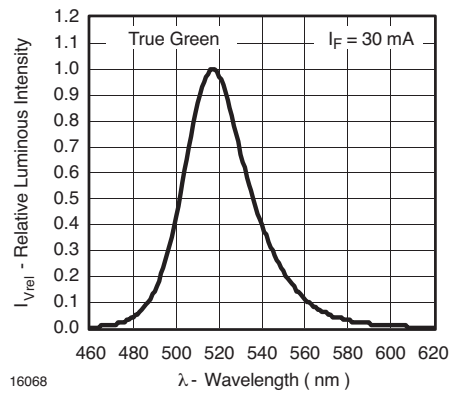


Figure 21. Relative Intensity vs. Wavelength

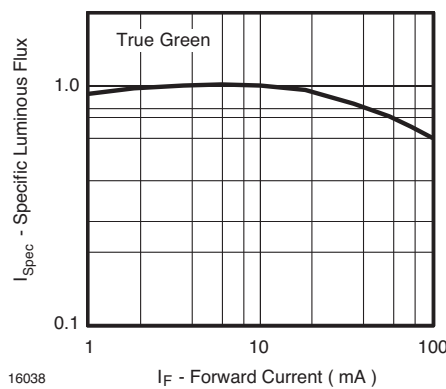


Figure 19. Specific Luminous Flux vs. Forward Current

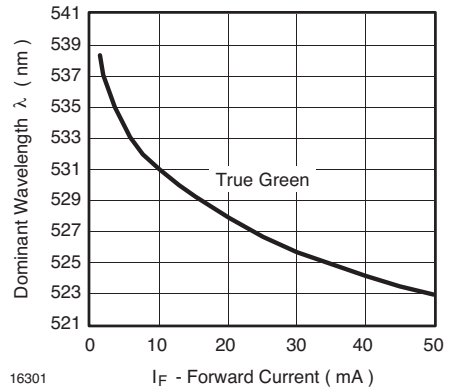


Figure 22. Dominant Wavelength vs. Forward Current

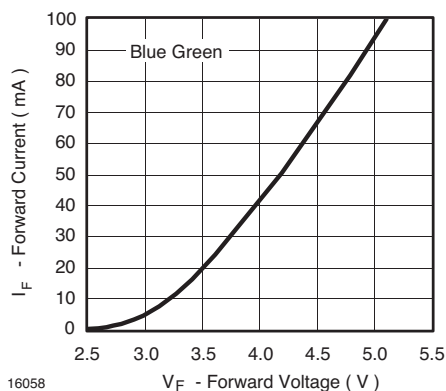


Figure 23. Forward Current vs. Forward Voltage

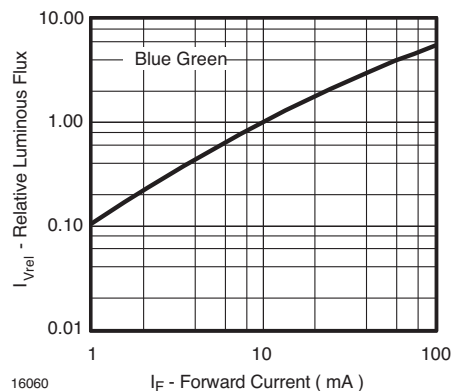


Figure 26. Relative Luminous Flux vs. Forward Current

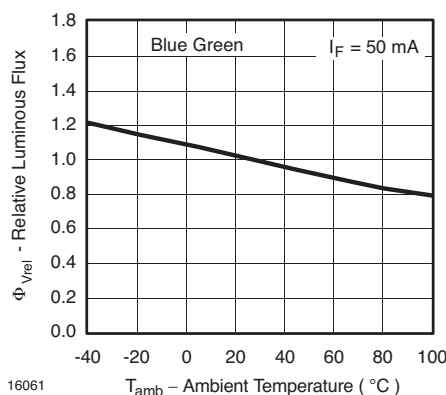


Figure 24. Rel. Luminous Flux vs. Ambient Temperature

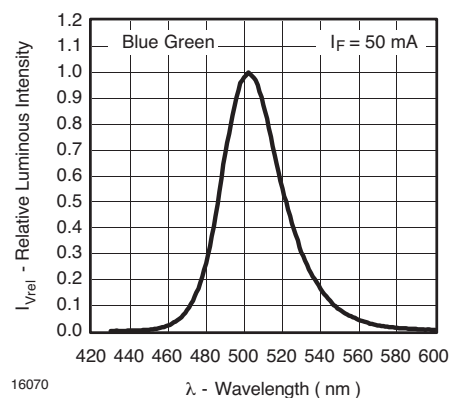


Figure 27. Relative Intensity vs. Wavelength

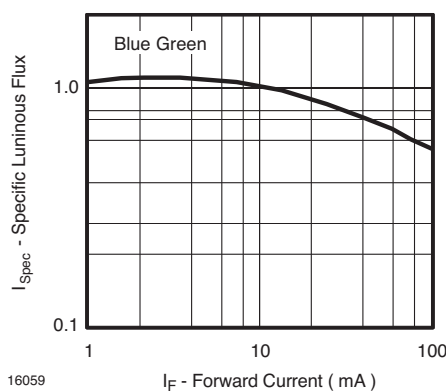


Figure 25. Specific Luminous Flux vs. Forward Current

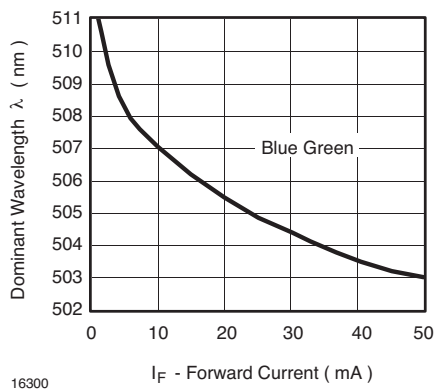


Figure 28. Dominant Wavelength vs. Forward Current

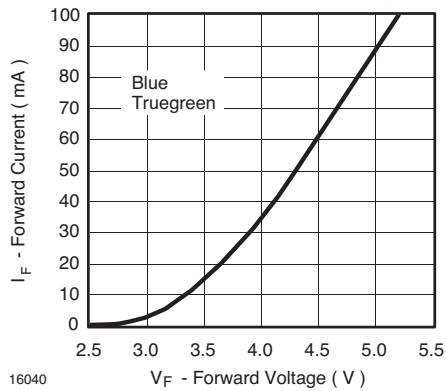


Figure 29. Forward Current vs. Forward Voltage

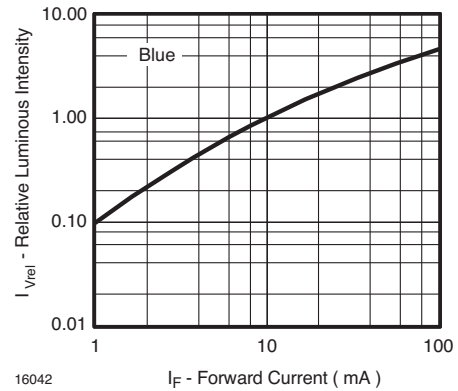


Figure 32. Relative Luminous Flux vs. Forward Current

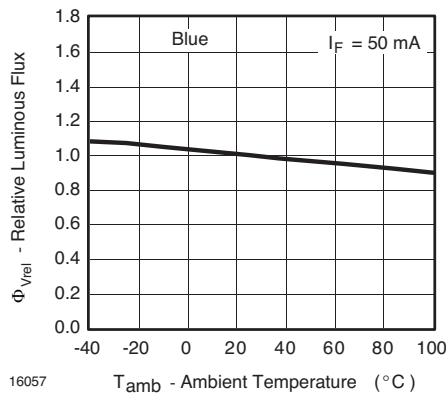


Figure 30. Rel. Luminous Flux vs. Ambient Temperature

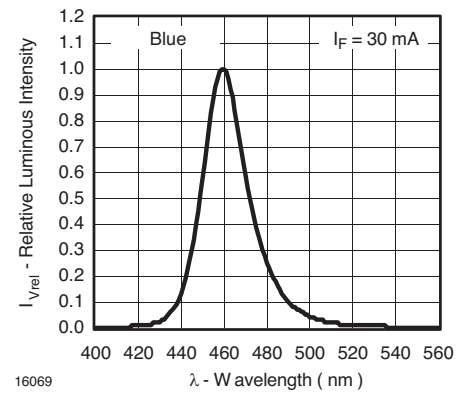


Figure 33. Relative Intensity vs. Wavelength

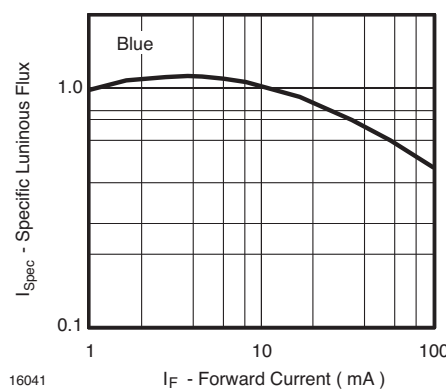


Figure 31. Specific Luminous Flux vs. Forward Current

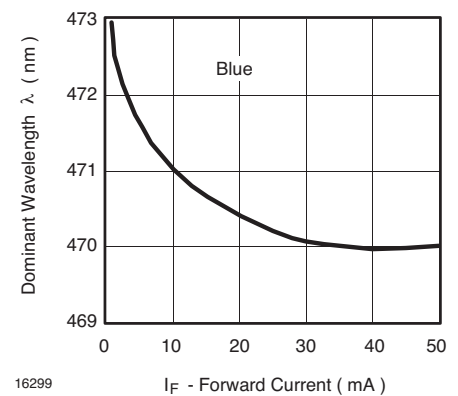
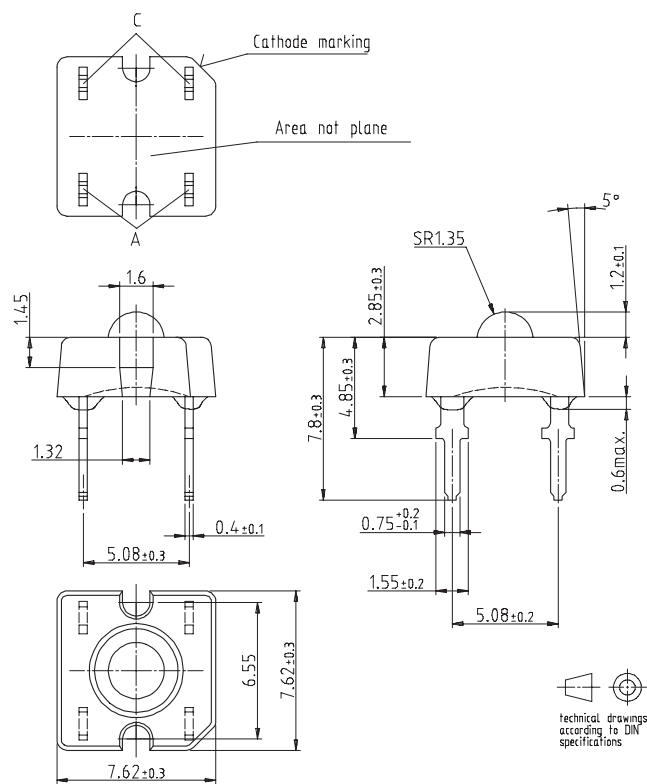


Figure 34. Dominant Wavelength vs. Forward Current

Package Dimensions in mm



16004



Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany
Telephone: 49 (0)7131 67 2831, Fax number: 49 (0)7131 67 2423